Silicon NPN Epitaxial

HITACHI

ADE-208-1130A (Z) 2nd. Edition Mar. 2001

Application

VHF / UHF wide band amplifier

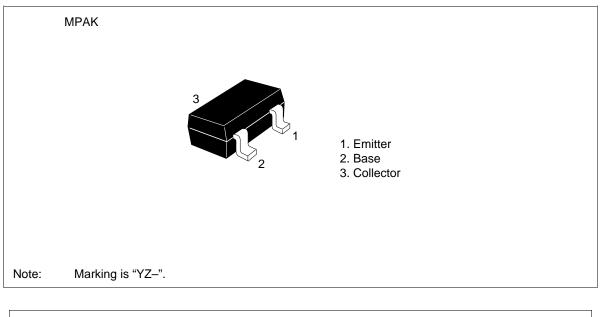
Features

• High gain bandwidth product

 $f_T = 11 \text{ GHz Typ}$

• High gain, low noise figure PG = 14.0 dB Typ, NF = 1.1 dB Typ at f = 900 MHz

Outline



Attention: This device is very sensitive to electro static discharge. It is recommended to adopt appropriate cautions when handling this transistor.



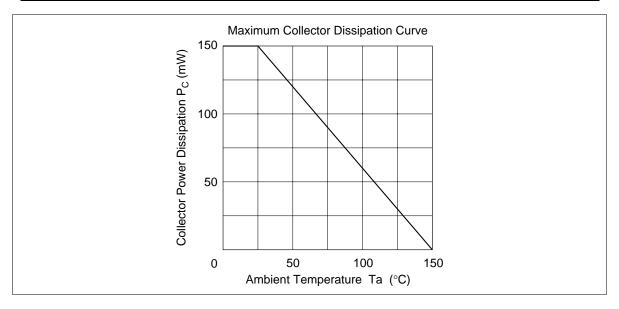
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	15	V
Collector to emitter voltage	V _{CEO}	8	V
Emitter to base voltage	V _{EBO}	1.5	V
Collector current	Ι _c	50	mA
Collector power dissipation	Pc	150	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

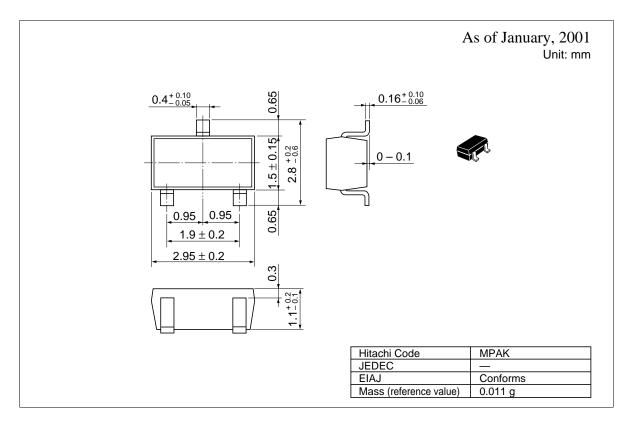
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector cutoff current	I _{CBO}	_	_	10	μΑ	$V_{CB} = 12 \text{ V}, \text{ I}_{E} = 0$
	I _{CEO}	—	—	1	mA	$V_{CE} = 8 \text{ V}, \text{ R}_{BE} = \infty$
Emitter cutoff current	I _{EBO}	_	_	10	μΑ	$V_{_{\rm EB}} = 1.5 \text{ V}, \text{ I}_{_{\rm C}} = 0$
DC current transfer ratio	h_{FE}	50	120	250		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 20 \text{ mA}$
Collector output capacitance	Cob	—	0.6	1.1	pF	$V_{CB} = 5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f _T	8.0	11.0	—	GHz	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 20 \text{ mA}$
S21 Parameter	S21	—	13.5	_	dB	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 20 \text{ mA},$ f = 1000 MHz
Power gain	PG	11.0	14.0	_	dB	$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 20 \text{ mA},$ f = 900 MHz
Noise figure	NF	_	1.1	2.0	dB	$V_{ce} = 5 \text{ V}, I_c = 5 \text{ mA}, f = 900 \text{ MHz}$

See characteristic curves of 2SC4926.



Package Dimensions



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Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica Europe	: http://semiconductor.hitachi.com/ : http://www.hitachi-eu.com/hel/ecg
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel : <886>-(2)-2718-3666 Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6933/538-3877 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building. Taipei (105), Taiwan Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

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